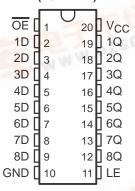
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- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 2 V at V_{CC} = 3.3 V, T_A = 25°C
- Support Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- Power Off Disables Outputs, Permitting Live Insertion
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and DIPs (J)

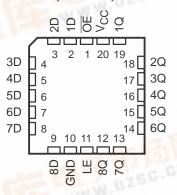
description

The SN54LVC573A octal transparent D-type latch is designed for 2.7-V to 3.6-V V_{CC} operation and the SN74LVC573A octal transparent D-type latch is designed for 1.65-V to 3.6-V V_{CC} operation.

SN54LVC573A . . . J OR W PACKAGE SN74LVC573A . . . DB, DW, OR PW PACKAGE (TOP VIEW)



SN54LVC573A ... FK PACKAGE (TOP VIEW)



These devices feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, input/output (I/O) ports, bidirectional bus drivers, and working registers.

While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the logic levels at the D inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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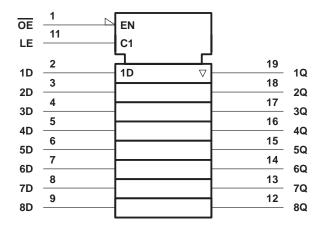
description (continued)

The SN54LVC573A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LVC573A is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each latch)

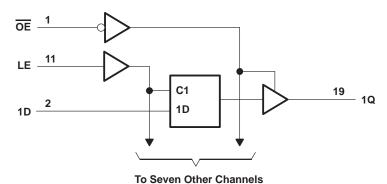
| | INPUTS | OUTPUT | |
|----|--------|--------|----------------|
| OE | LE | D | Q |
| L | Н | Н | Н |
| L | Н | L | L |
| L | L | Χ | Q ₀ |
| Н | Χ | Χ | Z |

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | |
|---|----------------|
| Voltage range applied to any output in the high-impedance or power- (see Note 1) | • |
| Voltage range applied to any output in the high or low state, V _O | 0.0 v to 0.0 v |
| (see Notes 1 and 2) | |
| Input clamp current, I _{IK} (V _I < 0) | |
| Output clamp current, I _{OK} (V _O < 0) | |
| Continuous output current, IO | |
| Continuous current through V _{CC} or GND | ±100 mA |
| Package thermal impedance, θ_{JA} (see Note 3): DB package | 115°C/W |
| - · · · · · · · · · · · · · · · · · · · | 97°C/W |
| PW package | |
| Storage temperature range, T _{stq} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The value of $V_{\hbox{\scriptsize CC}}$ is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

| | | | SN54LVC573A | | SN74L\ | SN74LVC573A | | |
|----------|------------------------------------|------------------------------------|-------------|-----|------------------------|------------------------|----------|--|
| | | | MIN | MAX | MIN | MAX | UNIT | |
| \/ | Cumphyyaltaga | Operating | 2 | 3.6 | 1.65 | 3.6 | V | |
| VCC | Supply voltage | Data retention only | 1.5 | | 1.5 | |] | |
| | | V _{CC} = 1.65 V to 1.95 V | | | 0.65 × V _{CC} | | | |
| V_{IH} | High-level input voltage | V _{CC} = 2.3 V to 2.7 V | | | 1.7 | | V | |
| | | V _{CC} = 2.7 V to 3.6 V | 2 | | 2 | | | |
| | | V _{CC} = 1.65 V to 1.95 V | | | | 0.35 × V _{CC} | | |
| V_{IL} | Low-level input voltage | V _{CC} = 2.3 V to 2.7 V | | | | 0.7 | V | |
| | | V _{CC} = 2.7 V to 3.6 V | | 0.8 | | 0.8 | 1 | |
| VI | Input voltage | | 0 | 5.5 | 0 | 5.5 | V | |
| \/- | Outracticallians | High or low state | 0 | Vcc | 0 | Vcс | V | |
| VO | Output voltage | 3 state | 0 | 5.5 | 0 | 5.5 | ٧ | |
| | | V _{CC} = 1.65 V | | | | -4 | | |
| la | High level cutout current | V _{CC} = 2.3 V | | | | -8 |]^ | |
| ЮН | High-level output current | V _{CC} = 2.7 V | | -12 | | -12 | mA | |
| | | VCC = 3 V | | -24 | | -24 | | |
| | | V _{CC} = 1.65 V | | | | 4 | | |
| la. | Low lovel output current | V _{CC} = 2.3 V | | | | 8 | mA | |
| lOL | Low-level output current | V _{CC} = 2.7 V | | 12 | | 12 | IIIA | |
| | | V _{CC} = 3 V | | 24 | | 24 | <u> </u> | |
| Δt/Δν | Input transition rise or fall rate | | 0 | 6 | 0 | 6 | ns/V | |
| TA | Operating free-air temperature | | -55 | 125 | -40 | 85 | °C | |

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETER | TEST CONDITIONS | | | SN54 | LVC573/ | 4 | SN74 | LVC573 | A | UNIT |
|------------------|--|--------|-----------------|----------------------|------------------|------|----------------------|--------|------|------|
| PARAMETER | TEST CONDITI | ONS | v _{CC} | MIN | TYP [†] | MAX | MIN | TYP† | MAX | UNII |
| | 100 | | 1.65 V to 3.6 V | | | | V _{CC} -0.2 | | | |
| | ΙΟΗ = -100 μΑ | | 2.7 V to 3.6 V | V _{CC} -0.2 | | | | | | |
| | I _{OH} = -4 mA | | 1.65 V | | | | 1.2 | | | |
| Voн | I _{OH} = -8 mA | | 2.3 V | | | | 1.7 | | | V |
| | I _{OH} = -12 mA | | 2.7 V | 2.2 | | | 2.2 | | | |
| | IOH = -12 IIIA | | 3 V | 2.4 | | | 2.4 | | | |
| | I _{OH} = -24 mA | | 3 V | 2.2 | | | 2.2 | | | |
| | I _{OL} = 100 μA | | 1.65 V to 3.6 V | | | | | | 0.2 | |
| | | | 2.7 V to 3.6 V | | | 0.2 | | | | |
| V | I _{OL} = 4 mA | | 1.65 V | | | | | | 0.45 | V |
| VOL | I _{OL} = 8 mA | | 2.3 V | | | | | | 0.7 | V |
| | I _{OL} = 12 mA | | 2.7 V | | | 0.4 | | | 0.4 | |
| | I _{OL} = 24 mA | | 3 V | | | 0.55 | | | 0.55 | |
| lį | $V_{ } = 0 \text{ to } 5.5 \text{ V}$ | | 3.6 V | | | ±5 | | | ±5 | μΑ |
| l _{off} | V_I or $V_O = 5.5 V$ | | 0 | | | | | | ±10 | μΑ |
| loz | $V_0 = 0 \text{ to } 5.5 \text{ V}$ | | 3.6 V | | | ±15 | | | ±10 | μΑ |
| | V _I = V _{CC} or GND | 1- 0 | 201 | | | 10 | | | 10 | ^ |
| Icc | $3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{\ddagger}$ | IO = 0 | 3.6 V | | | 10 | | | 10 | μΑ |
| ΔICC | One input at V _{CC} – 0.6 Other inputs at V _{CC} or | | 2.7 V to 3.6 V | | | 500 | | | 500 | μΑ |
| Ci | $V_I = V_{CC}$ or GND | | 3.3 V | | 4 | | | 4 | | pF |
| Co | $V_O = V_{CC}$ or GND | | 3.3 V | | 5.5 | | | 5.5 | | pF |

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| | | | SN54L\ | | | |
|-----------------|-----------------------------|-------------------------|--------|------------------------------------|-----|------|
| | | V _{CC} = 2.7 V | | V _{CC} = 3.3 V ± 0.3 V | | UNIT |
| | | MIN | MAX | MIN | MAX | |
| t _W | Pulse duration, LE high | 3.3 | | 3.3 | | ns |
| t _{su} | Setup time, data before LE↓ | 2 | | 2 | | ns |
| th | Hold time, data after LE↓ | 2.5 | | 2.5 | | ns |



[‡] This applies in the disabled state only.

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

| | SN74LVC573A | | | | | | | | | |
|-----------------|-----------------------------|-----|--------------|-------------------|-----|-------------------|-------|-------------------|--------------|------|
| | | | 1.8 V 5 V | V _{CC} = | | V _{CC} = | 2.7 V | V _{CC} = | 3.3 V 3 V | UNIT |
| | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _W | Pulse duration, LE high | † | | † | | 3.3 | | 3.3 | | ns |
| t _{su} | Setup time, data before LE↓ | † | | † | | 2 | | 2 | | ns |
| th | Hold time, data after LE↓ | † | | † | | 1.5 | | 1.5 | | ns |

[†] This information was not available at the time of publication.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| | | | SN54L\ | | | |
|------------------|-----------------|----------------|-------------------------|------------------------------------|-----|------|
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = 2.7 V | V _{CC} = 3.3 V ± 0.3 V | | UNIT |
| | | | MIN MAX | MIN | MAX | |
| | D | Q | 7.7 | 1 | 6.9 | no |
| ^t pd | LE | Q | 8.4 | 1 | 7.7 | ns |
| t _{en} | ŌĒ | Q | 8.5 | 1 | 7.5 | ns |
| t _{dis} | ŌĒ | Q | 7 | 0.5 | 6.7 | ns |

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

| | | TO (OUTPUT) | SN74LVC573A | | | | | | | | |
|----------------------|-----------------|----------------|-------------------------|-----|-------------------|--------------|-------|-------|-------------------|--------------|------|
| PARAMETER | FROM (INPUT) | | V _{CC} = ± 0.1 | | V _{CC} = | 2.5 V 2 V | VCC = | 2.7 V | V _{CC} = | 3.3 V 3 V | UNIT |
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | D | Q | † | † | † | † | | 7.7 | 1.5 | 6.9 | ns |
| ^t pd | LE | | † | † | † | † | | 8.4 | 2 | 7.7 | 115 |
| t _{en} | ŌĒ | Q | † | † | † | † | | 8.5 | 1.5 | 7.5 | ns |
| ^t dis | ŌĒ | Q | † | † | † | † | | 7 | 1.6 | 6.5 | ns |
| t _{sk(o)} ‡ | | | | | | | | | | 1 | ns |

[†] This information was not available at the time of publication.

operating characteristics, T_A = 25°C

| PARAMETER | | | TEST CONDITIONS | V _{CC} = 1.8 V ± 0.15 V | V _{CC} = 2.5 V ± 0.2 V | V _{CC} = 3.3 V ± 0.3 V | UNIT |
|-----------------|-------------------------------|------------------|--------------------|-------------------------------------|------------------------------------|------------------------------------|------|
| | | CONDITIONS | TYP | TYP | TYP | | |
| C _{pd} | Power dissipation capacitance | Outputs enabled | f = 10 MHz | † | † | 37 | pF |
| Cpa | per latch | Outputs disabled | 1 = 10 MH2 | † | † | 4 | þг |

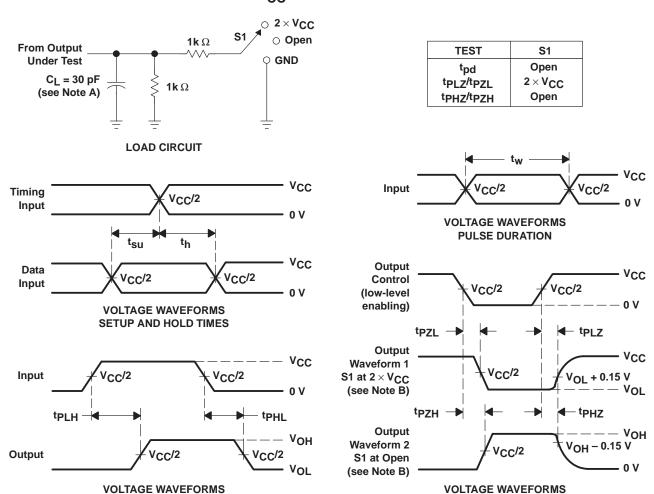
 $[\]dagger$ This information was not available at the time of publication.



[‡] Skew between any two outputs of the same package switching in the same direction

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PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

ENABLE AND DISABLE TIMES

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq$ 2 ns. $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.

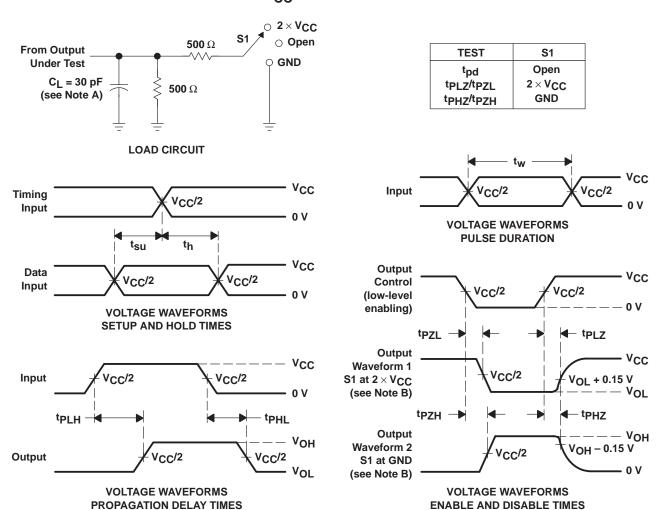
PROPAGATION DELAY TIMES

- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$



NOTES: A. C_L includes probe and jig capacitance.

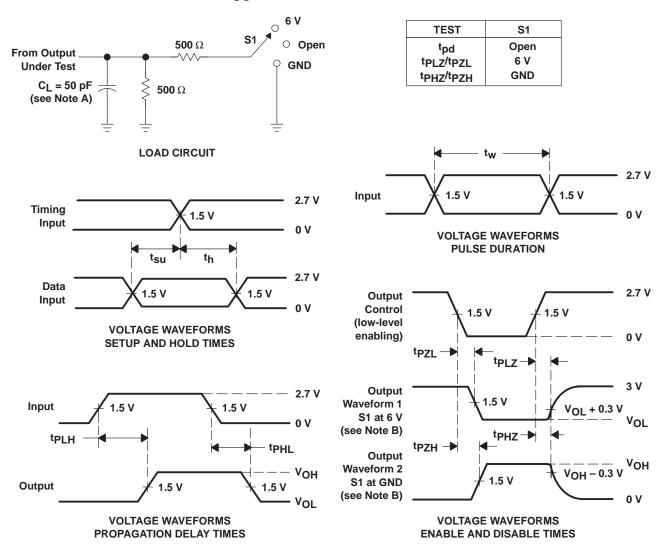
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f \leq$ 2 ns. $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms



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PARAMETER MEASUREMENT INFORMATION V_{CC} = 2.7 V AND 3.3 V \pm 0.3 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms

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